

$V_{DSM} = 6500 \text{ V}$
 $I_{TAVM} = 2816 \text{ A}$
 $I_{TRMS} = 4410 \text{ A}$
 $I_{TSM} = 45000 \text{ A}$
 $V_{T0} = 1.12 \text{ V}$
 $r_T = 0.29 \text{ m}\Omega$

Phase Control Thyristor

5STP 26N6500

Doc. No. 5SYA1001-03 Jan. 02

- Patented free-floating silicon technology
- Low on-state and switching losses
- Designed for traction, energy and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate

Blocking

Maximum rated values ¹⁾

Symbol	Conditions	5STP 26N6500	5STP 26N6200	5STP 26N5800
V_{DSM}, V_{RSM}	$f = 5 \text{ Hz}, t_p = 10 \text{ ms}$	6500 V	6200 V	5800 V
V_{DRM}, V_{RRM}	$f = 50 \text{ Hz}, t_p = 10 \text{ ms}$	5600 V	5300 V	4900 V
V_{RSM1}	$t_p = 5 \text{ ms}, \text{ single pulse}$	7000 V	6700 V	6300 V
dV/dt_{crit}	Exp. to $0.67 \times V_{DRM}, T_j = 125^\circ\text{C}$	2000 V/ μs		

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Forward leakage current	I_{DSM}	$V_{DSM}, T_j = 125^\circ\text{C}$			600	mA
Reverse leakage current	I_{RSM}	$V_{RSM}, T_j = 125^\circ\text{C}$			600	mA

V_{DRM}/V_{RRM} are equal to V_{DSM}/V_{RSM} values up to $T_j = 110^\circ\text{C}$

Mechanical data

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		81	90	108	kN
Acceleration	a	Device unclamped			50	m/s^2
Acceleration	a	Device clamped			100	m/s^2

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m			2.9		kg
Surface creepage distance	D_s		56			mm
Air strike distance	D_a		22			mm

¹⁾ Maximum Ratings are those values beyond which damage to the device may occur

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On-state

Maximum rated values ¹⁾ 供应商

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. average on-state current	I_{TAVM}	Half sine wave, $T_c = 70^\circ\text{C}$			2810	A
RMS on-state current	I_{TRMS}				4410	A
Max. peak non-repetitive surge current	I_{TSM}	$t_p = 10\text{ ms}$, $T_j = 125^\circ\text{C}$, $V_D = V_R = 0\text{ V}$			45000	A
Limiting load integral	I^2t				10125	kA^2s
Max. peak non-repetitive surge current	I_{TSM}	$t_p = 8.3\text{ ms}$, $T_j = 125^\circ\text{C}$, $V_D = V_R = 0\text{ V}$			50000	A
Limiting load integral	I^2t				10375	kA^2s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 3000\text{ A}$, $T_j = 125^\circ\text{C}$			2	V
Threshold voltage	V_{T0}	$I_T = 1300\text{ A} - 4000\text{ A}$, $T_j = 125^\circ\text{C}$			1.12	V
Slope resistance	r_T	$T_j = 125^\circ\text{C}$			0.29	$\text{m}\Omega$
Holding current	I_H	$T_j = 25^\circ\text{C}$			125	mA
		$T_j = 125^\circ\text{C}$			75	mA
Latching current	I_L	$T_j = 25^\circ\text{C}$			500	mA
		$T_j = 125^\circ\text{C}$			250	mA

Switching

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di/dt_{crit}	$T_j = 125^\circ\text{C}$, $I_{TRM} = 3000\text{ A}$, $V_D \leq 0.67 \cdot V_{DRM}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu\text{s}$		Cont. $f = 50\text{ Hz}$	200	$\text{A}/\mu\text{s}$
Critical rate of rise of on-state current	di/dt_{crit}			Cont. $f = 1\text{ Hz}$	1000	$\text{A}/\mu\text{s}$
Circuit-commutated turn-off time	t_q	$T_j = 125^\circ\text{C}$, $I_{TRM} = 3000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1\text{ A}/\mu\text{s}$, $V_D \leq 0.67 \cdot V_{DRM}$, $dv_D/dt = 20\text{ V}/\mu\text{s}$,	800			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Recovery charge	Q_{rr}	$T_j = 125^\circ\text{C}$, $I_{TRM} = 3000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1\text{ A}/\mu\text{s}$	2700		3700	μAs
Delay time	t_d	$V_D = 0.4 \cdot V_{DRM}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ }\mu\text{s}$			3	μs

Triggering

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	V _{FGM}				12	V
Peak forward gate current	I _{FGM}				10	A
Peak reverse gate voltage	V _{RGM}				10	V
Gate power loss	P _G	For DC gate current			3	W
Average gate power loss	P _{GAV}			see Fig. 9		

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate trigger voltage	V _{GT}	T _j = 25°C			2.6	V
Gate trigger current	I _{GT}	T _j = 25°C			400	mA
Gate non-trigger voltage	V _{GD}	V _D = 0.4 x V _{DRM} , T _{vjmax} = 125°C	0.3			V
Gate non-trigger current	I _{GD}	V _D = 0.4 x V _{DRM} , T _{vjmax} = 125°C	10			mA

Thermal

Maximum rated values ¹⁾

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T _j				125	°C
Storage temperature range	T _{stg}		-40		140	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case	R _{th(j-c)}	Double side cooled			5.7	K/kW
	R _{th(j-c)A}	Anode side cooled			11.4	K/kW
	R _{th(j-c)C}	Cathode side cooled			11.4	K/kW
Thermal resistance case to heatsink	R _{th(c-h)}	Double side cooled			1	K/kW
	R _{th(c-h)}	Single side cooled			2	K/kW

Analytical function for transient thermal impedance:

$$Z_{thJC}(t) = \sum_{i=1}^n R_i(1 - e^{-t/\tau_i})$$

i	1	2	3	4
R _i (K/kW)	3.4	1.26	0.68	0.35
τ _i (s)	0.8685	0.1572	0.0219	0.0078

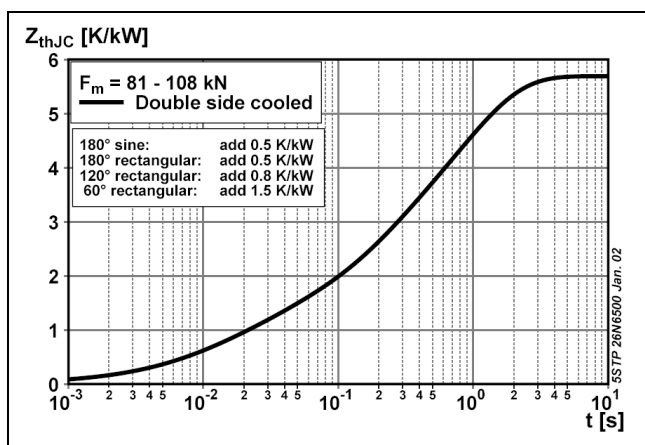


Fig. 1 Transient thermal impedance junction-to case.

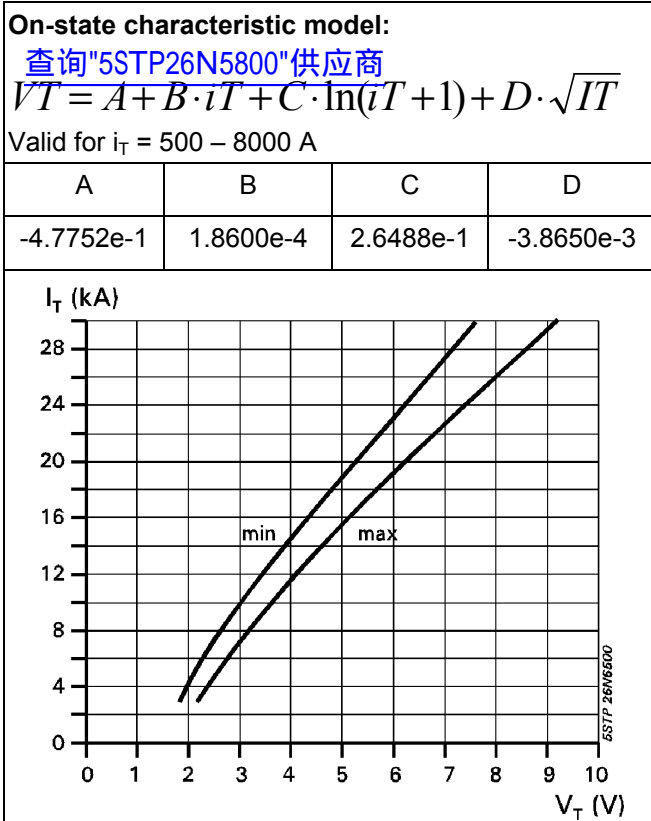


Fig. 2 On-state characteristics.
 $T_j = 125^\circ\text{C}$, 10ms half sine

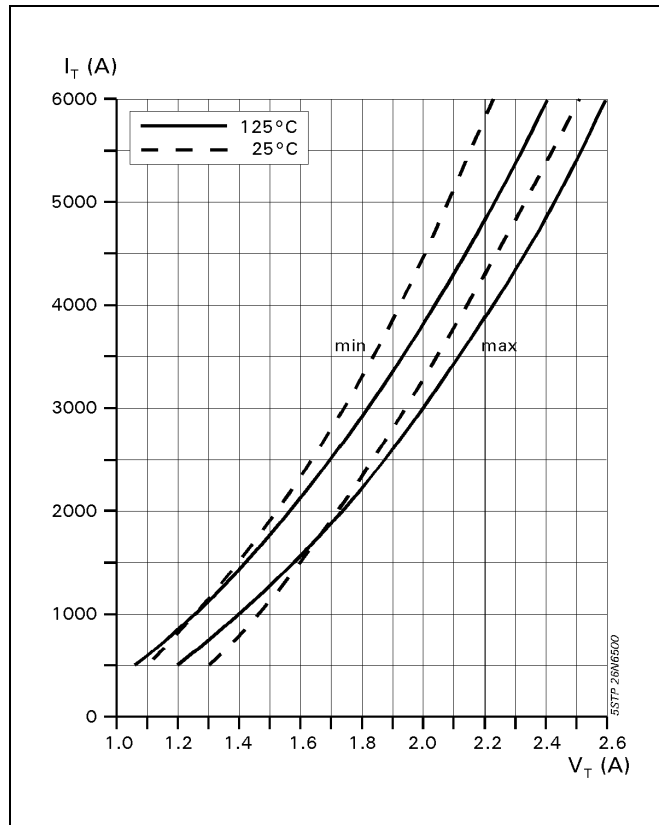


Fig. 3 On-state characteristics.

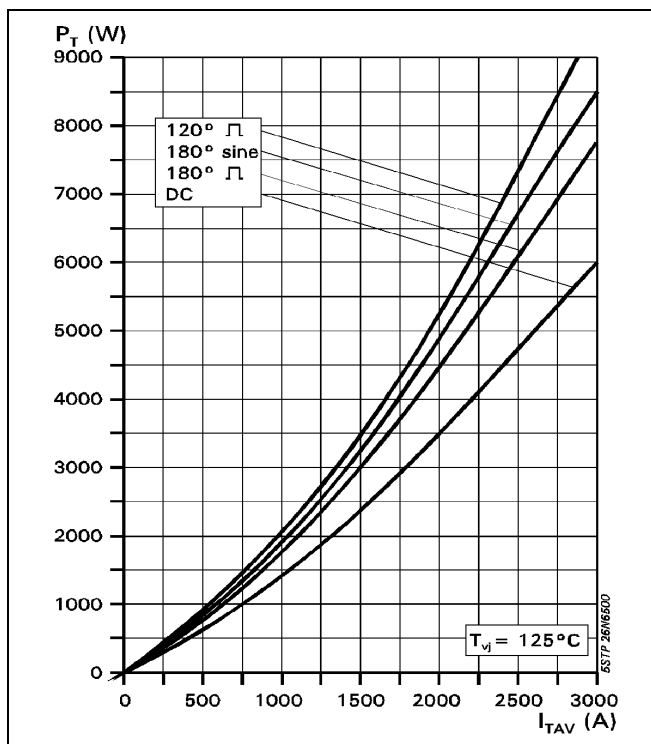


Fig. 4 On-state power dissipation vs. mean on-state current. Turn - on losses excluded.

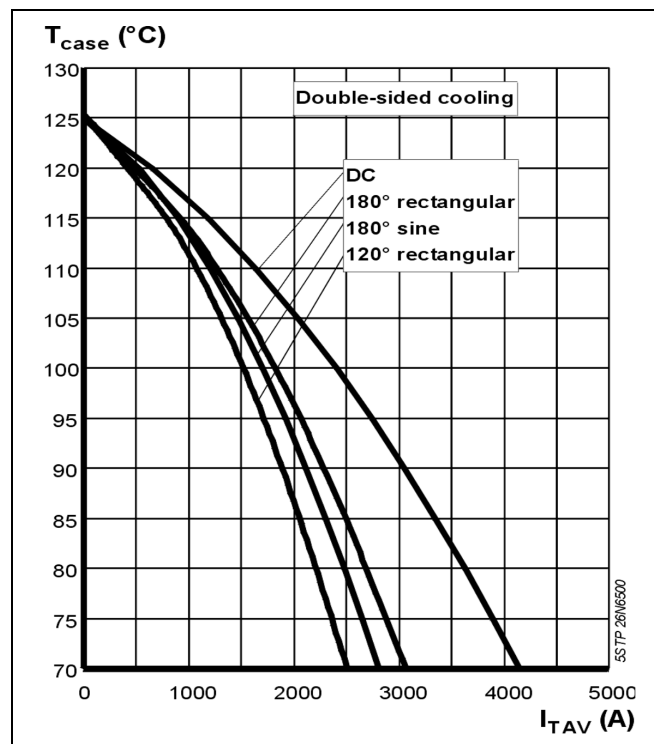


Fig. 5 Max. permissible case temperature vs. mean on-state current.

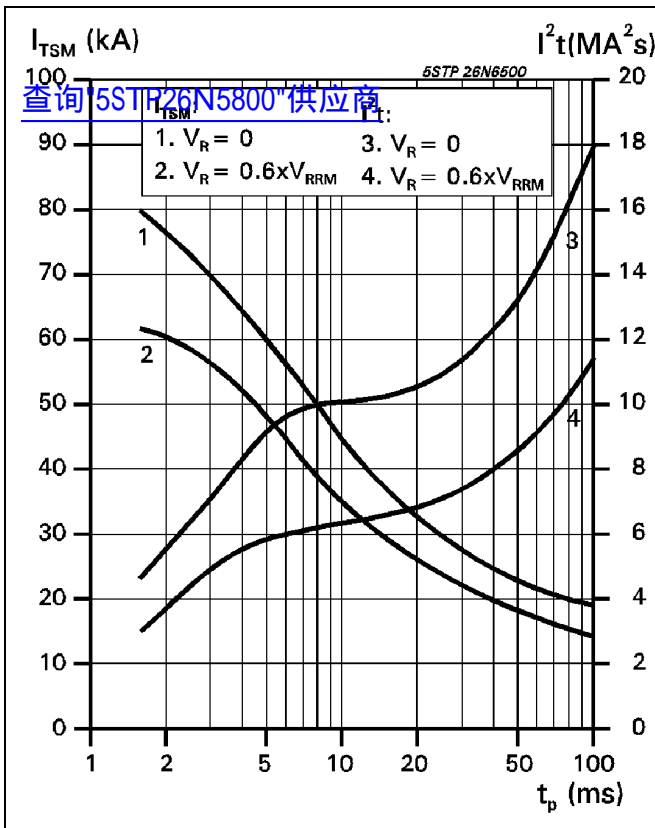


Fig. 6 Surge on-state current vs. pulse length. Half-sine wave.

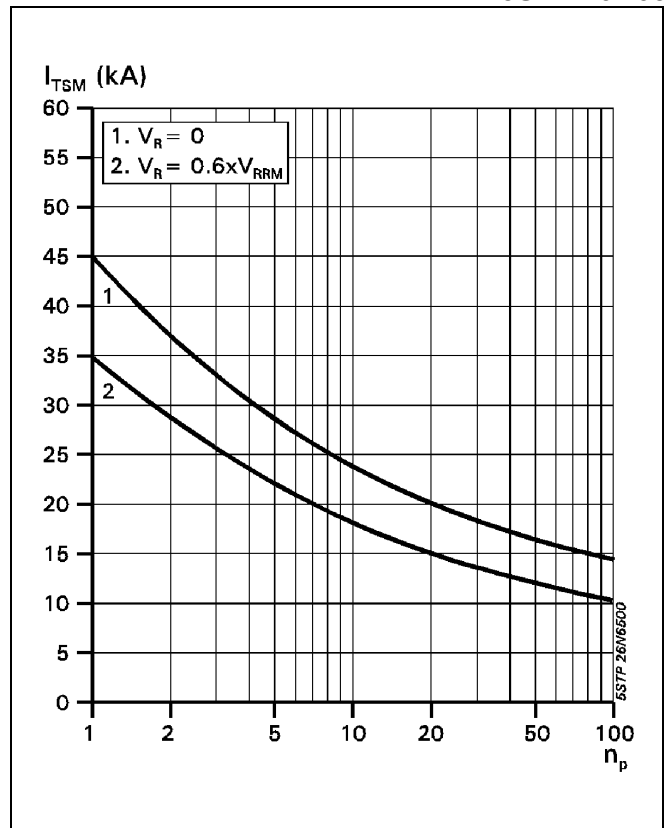


Fig. 7 Surge on-state current vs. number of pulses. Half-sine wave, 10 ms, 50Hz.

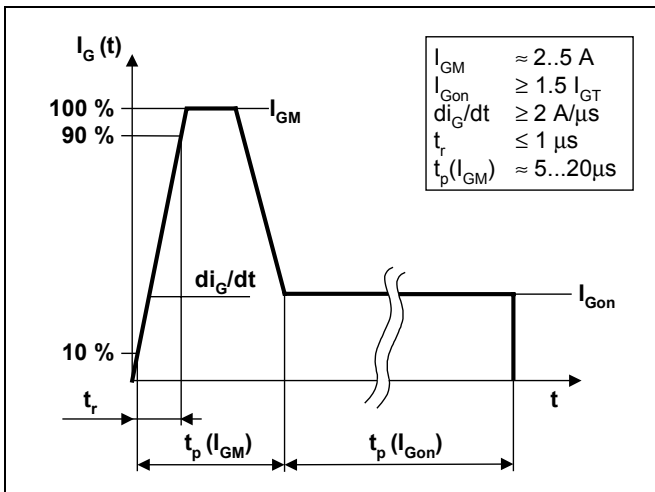


Fig. 8 Recommended gate current waveform.

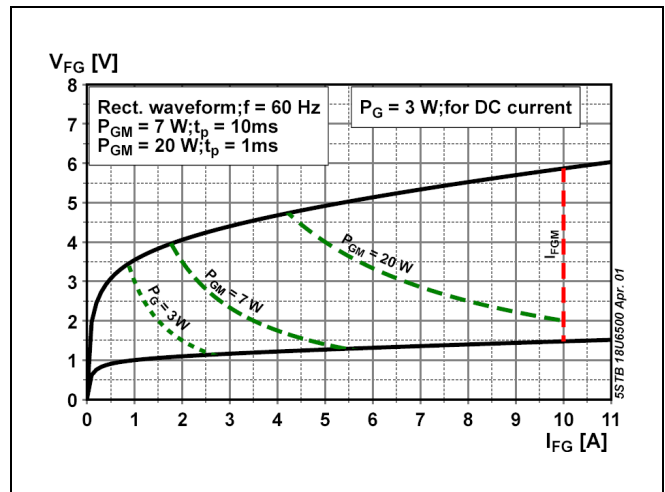


Fig. 9 Max. peak gate power loss.

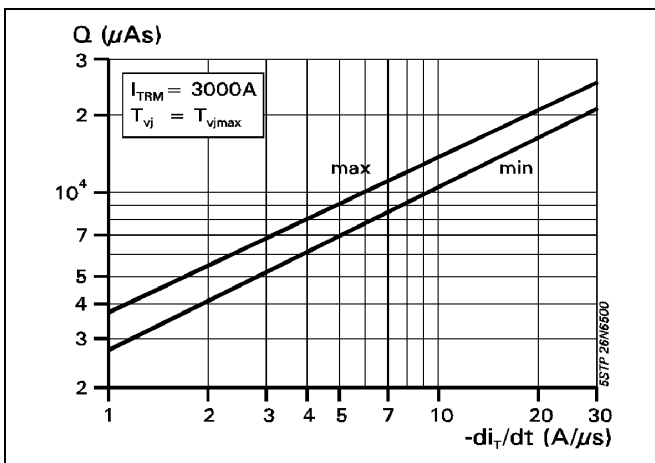


Fig. 10 Recovery charge vs. decay rate of on-state current.

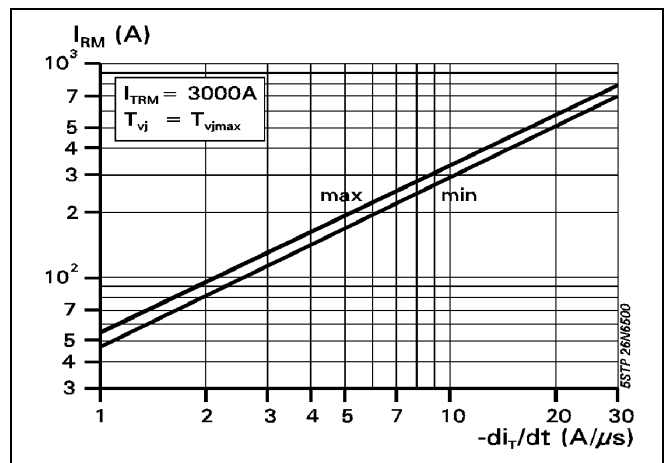


Fig. 11 Peak reverse recovery current vs. decay rate of on-state current.

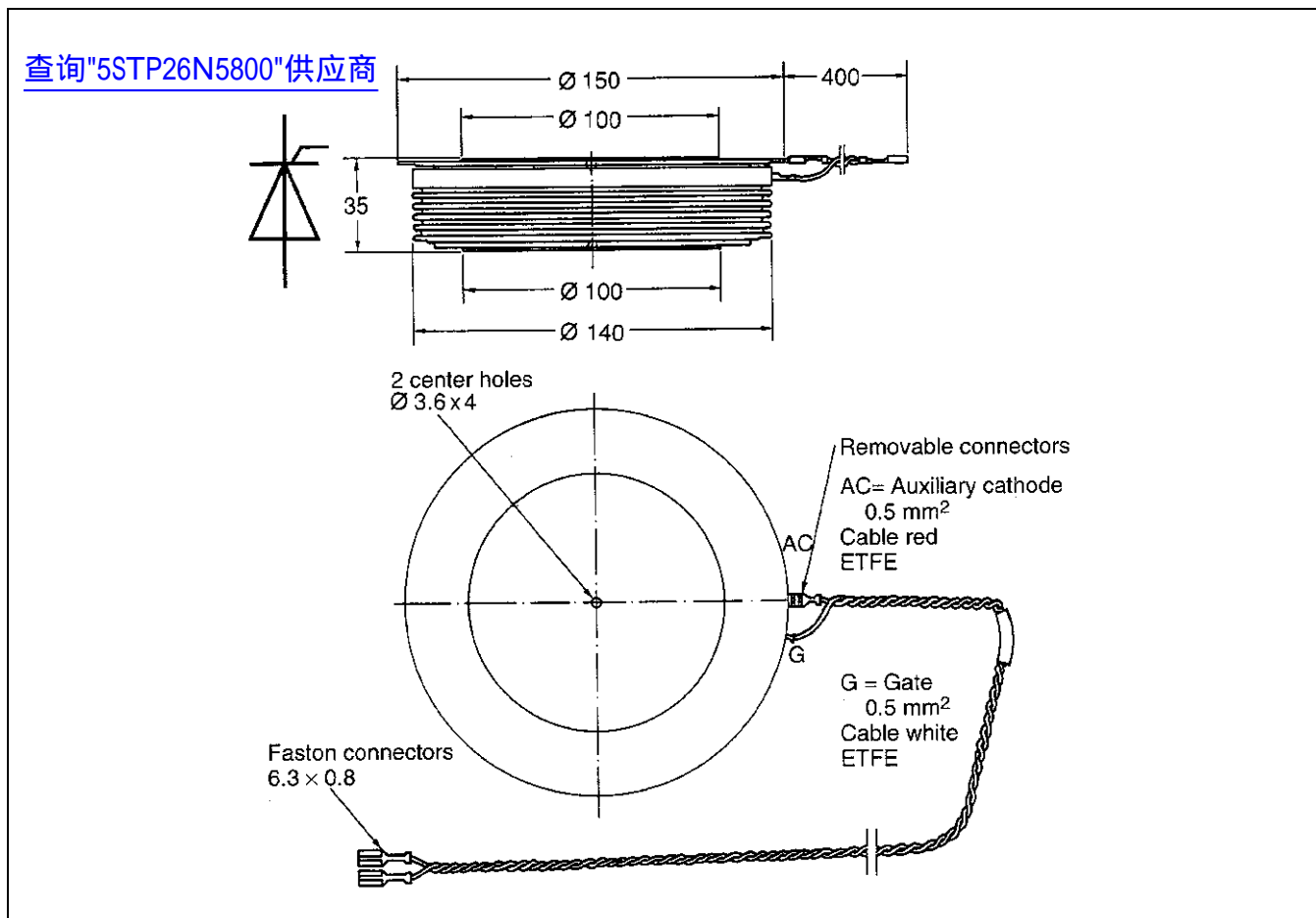


Fig. 12 Device Outline Drawing.

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